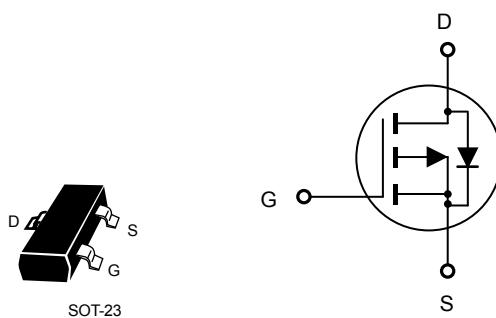


## P-Channel Enhancement Mode Field Effect Transistor

### FEATURES

- -30V, -3.2A,  $R_{DS(ON)} = 78m\Omega$  @ $V_{GS} = -10V$ .
- $R_{DS(ON)} = 120m\Omega$  @ $V_{GS} = -4.5V$ .
- High dense cell design for extremely low  $R_{DS(ON)}$ .
- Rugged and reliable.
- Lead free product is acquired.
- SOT-23 package.



### ABSOLUTE MAXIMUM RATINGS

$T_A = 25^\circ C$  unless otherwise noted

| Parameter                             | Symbol         | Limit      | Units      |
|---------------------------------------|----------------|------------|------------|
| Drain-Source Voltage                  | $V_{DS}$       | -30        | V          |
| Gate-Source Voltage                   | $V_{GS}$       | $\pm 20$   | V          |
| Drain Current-Continuous              | $I_D$          | -3.2       | A          |
| Drain Current-Pulsed <sup>a</sup>     | $I_{DM}$       | -12        | A          |
| Maximum Power Dissipation             | $P_D$          | 1.25       | W          |
| Operating and Store Temperature Range | $T_J, T_{Stg}$ | -55 to 150 | $^\circ C$ |

### Thermal Characteristics

| Parameter  | Symbol          | Limit | Units        |
|--|-----------------|-------|--------------|
| Thermal Resistance, Junction-to-Ambient <sup>b</sup> | $R_{\theta JA}$ | 100   | $^\circ C/W$ |



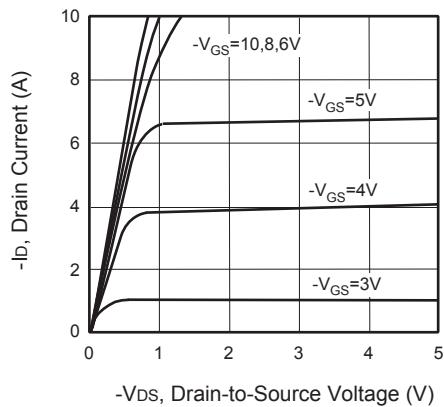
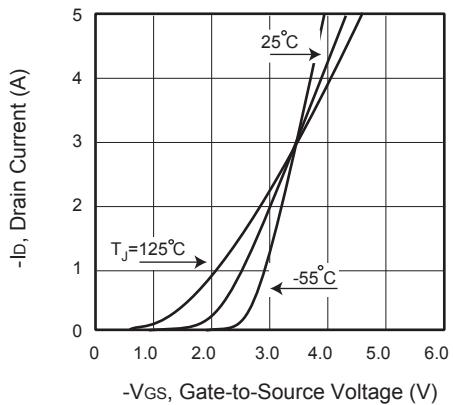
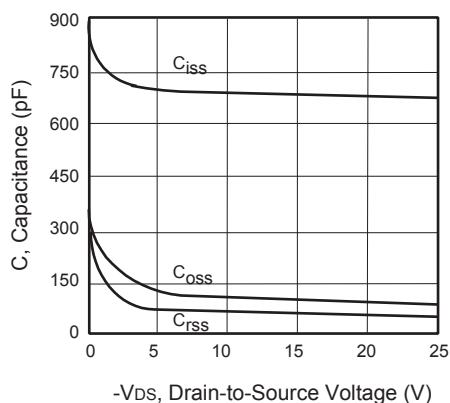
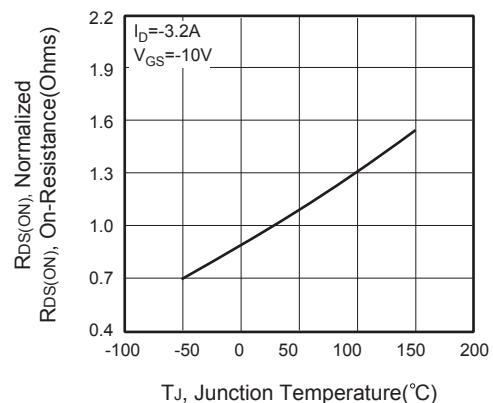
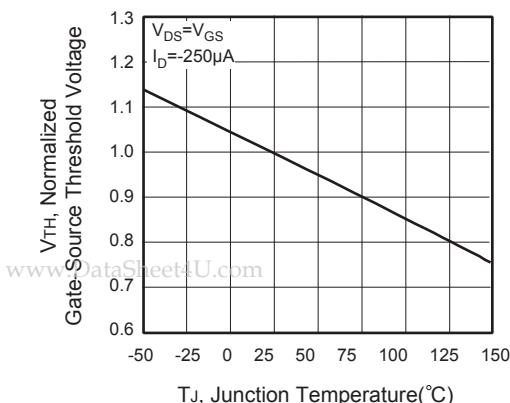
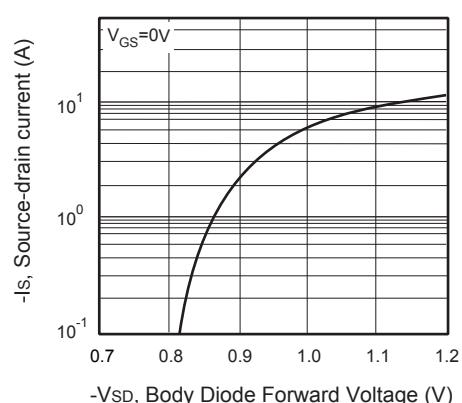
# CES2307

## Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

| Parameter   | Symbol                     | Test Condition   | Min | Typ | Max  | Units            |
|---|----------------------------|--|-----|-----|------|------------------|
| <b>Off Characteristics</b>                                    |                            |  |     |     |      |                  |
| Drain-Source Breakdown Voltage                                | $\text{BV}_{\text{DSS}}$   | $V_{\text{GS}} = 0\text{V}, I_{\text{D}} = -250\mu\text{A}$  | -30 |     |      | V                |
| Zero Gate Voltage Drain Current                               | $I_{\text{DSS}}$           | $V_{\text{DS}} = -30\text{V}, V_{\text{GS}} = 0\text{V}$   |     |     | -1   | $\mu\text{A}$    |
| Gate Body Leakage Current, Forward                            | $I_{\text{GSSF}}$          | $V_{\text{GS}} = 20\text{V}, V_{\text{DS}} = 0\text{V}$  |     |     | 100  | nA               |
| Gate Body Leakage Current, Reverse                            | $I_{\text{GSSR}}$          | $V_{\text{GS}} = -20\text{V}, V_{\text{DS}} = 0\text{V}$   |     |     | -100 | nA               |
| <b>On Characteristics<sup>c</sup></b>                         |                            |  |     |     |      |                  |
| Gate Threshold Voltage  | $V_{\text{GS}(\text{th})}$ | $V_{\text{GS}} = V_{\text{DS}}, I_{\text{D}} = -250\mu\text{A}$  | -1  |     | -3   | V                |
| Static Drain-Source On-Resistance                             | $R_{\text{DS}(\text{on})}$ | $V_{\text{GS}} = -10\text{V}, I_{\text{D}} = -3.2\text{A}$<br>$V_{\text{GS}} = -4.5\text{V}, I_{\text{D}} = -2.5\text{A}$    |     | 60  | 78   | $\text{m}\Omega$ |
| <b>Dynamic Characteristics<sup>d</sup></b>                    |                            |  |     |     |      |                  |
| Forward Transconductance                                      | $g_{\text{FS}}$            | $V_{\text{DS}} = -10\text{V}, I_{\text{D}} = -3.2\text{A}$   |     | 5   |      | S                |
| Input Capacitance   | $C_{\text{iss}}$           | $V_{\text{DS}} = -15\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$  |     | 640 |      | pF               |
| Output Capacitance  | $C_{\text{oss}}$           |  |     | 130 |      | pF               |
| Reverse Transfer Capacitance                                  | $C_{\text{rss}}$           |  |     | 95  |      | pF               |
| <b>Switching Characteristics<sup>d</sup></b>                  |                            |  |     |     |      |                  |
| Turn-On Delay Time  | $t_{\text{d(on)}}$         | $V_{\text{DD}} = -15\text{V}, I_{\text{D}} = -1\text{A}, \square$<br>$V_{\text{GS}} = -10\text{V}, R_{\text{GEN}} = 6\Omega$ |     | 11  | 22   | ns               |
| Turn-On Rise Time   | $t_r$                      |  |     | 5   | 10   | ns               |
| Turn-Off Delay Time   | $t_{\text{d(off)}}$        |  |     | 30  | 60   | ns               |
| Turn-Off Fall Time  | $t_f$                      |  |     | 7   | 14   | ns               |
| Total Gate Charge   | $Q_g$                      | $V_{\text{DS}} = -15\text{V}, I_{\text{D}} = -3.2\text{A}, V_{\text{GS}} = -10\text{V}$                                      |     | 9.5 | 12.5 | nC               |
| Gate-Source Charge  | $Q_{\text{gs}}$            |  |     | 3.4 |      | nC               |
| Gate-Drain Charge   | $Q_{\text{gd}}$            |  |     | 1.7 |      | nC               |
| <b>Drain-Source Diode Characteristics and Maximum Ratings</b> |                            |  |     |     |      |                  |
| Drain-Source Diode Forward Current <sup>b</sup>               | $I_s$                      |  |     |     | -3.2 | A                |
| Drain-Source Diode Forward Voltage <sup>c</sup>               | $V_{\text{SD}}$            | $V_{\text{GS}} = 0\text{V}, I_s = -0.75\text{A}$   |     |     | -1.2 | V                |

Notes :

- a.Repetitive Rating : Pulse width limited by maximum junction temperature. $\square$
- b.Surface Mounted on FR4 Board,  $t < 5$  sec. $\square$
- c.Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ . $\square$
- d.Guaranteed by design, not subject to production testing. $\square$

**Figure 1. Output Characteristics****Figure 2. Transfer Characteristics****Figure 3. Capacitance****Figure 4. On-Resistance Variation with Temperature****Figure 5. Gate Threshold Variation with Temperature****Figure 6. Body Diode Forward Voltage Variation with Source Current**

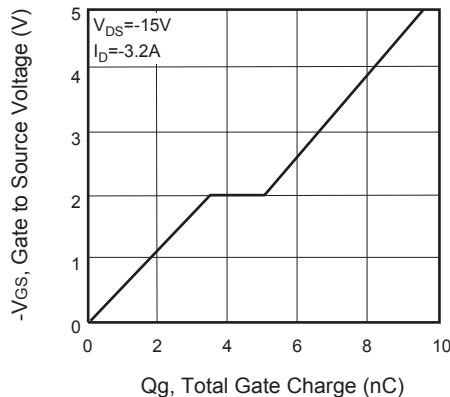


Figure 7. Gate Charge

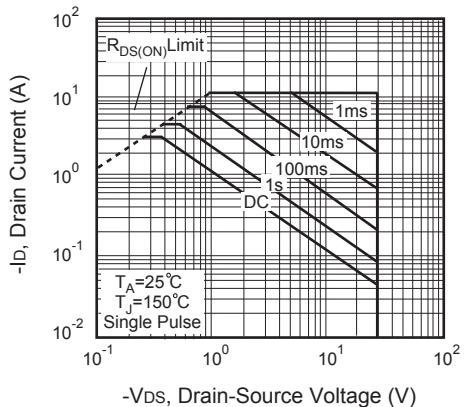


Figure 8. Maximum Safe Operating Area

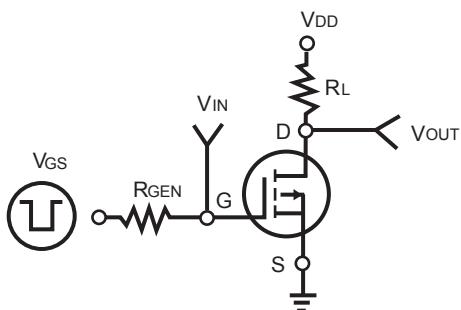


Figure 9. Switching Test Circuit

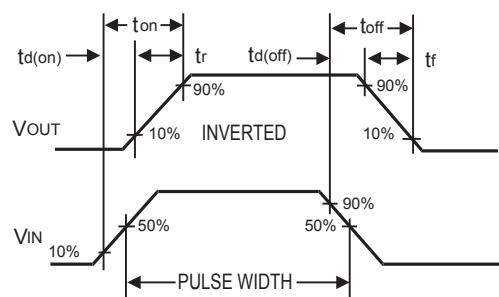


Figure 10. Switching Waveforms

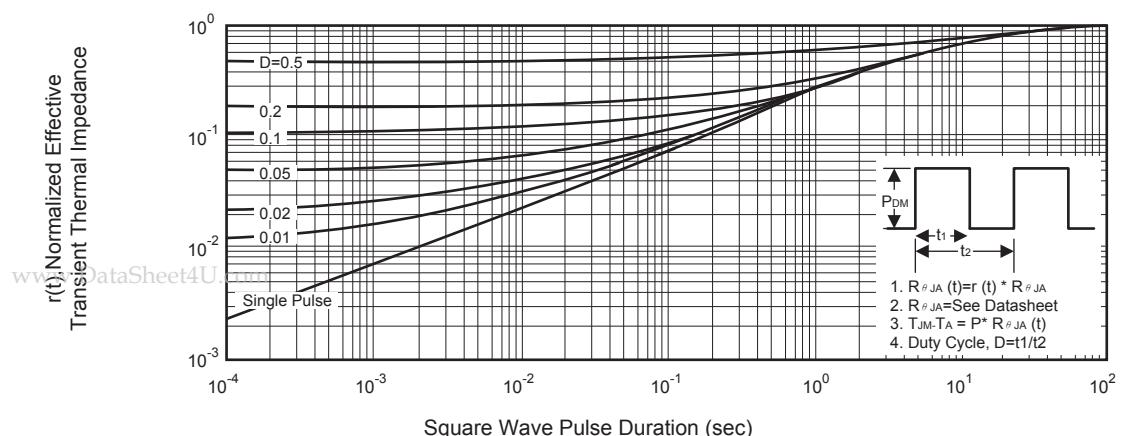


Figure 11. Normalized Thermal Transient Impedance Curve